

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT4284102

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	STEVEN W. ELLISON	02/16/2016
	DAVID KNAGGS	02/16/2016
RECEIVING PARTY DATA		
Name:	TELECT, INC.	
Street Address:	PO BOX 665	
City:	LIBERTY LAKE	
State/Country:	WASHINGTON	
Postal Code:	99019	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	15046186
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ATTORNEY DOCKET NUMBER:	TL1-0164US	
NAME OF SUBMITTER:	JENNIFER PHIPPS	
SIGNATURE:	/Jennifer Phipps/	
DATE SIGNED:	02/21/2017	
Total Attachments: 2		
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Serial Number.....
Filing Date.....
Inventorship..... Ellison et al.
Applicant..... Telect, Inc.
Attorney's Docket No. TL1-0164US
Title..... Ultra-High Density Patch Systems

PATENT ASSIGNMENT

PARTIES TO THE ASSIGNMENT

Assignor(s):

Steven W. Ellison
Mead, WA 99021

David Knaggs
Spokane, WA US

Assignee:

Telect, Inc.
PO Box 665
Liberty Lake, WA, 99019

AGREEMENT

WHEREAS, ASSIGNOR(S) (listed above) are inventor(s) of an invention entitled
"Ultra-High Density Patch Systems" for which:

☒ a non-provisional application for United States Letters Patent was:

☒ filed on 02/17/2016 and was given U.S. Serial No. 15/046,186; or filed
concurrently herewith. Assignors hereby authorize and request ASSIGNEE's legal
representatives, of Lee & Hayes, PLLC, 601 W Riverside Ave, Suite 1400, Spokane, Washington
99201, who are associated with customer number 29150, to insert in the caption above the serial
number and filing date of the patent application when known.

WHEREAS, Telect, Inc. (hereinafter referred to as ASSIGNEE), a corporation of the State
of WA having a place of business at PO Box 665, Liberty Lake, WA 99019, desires to acquire the

entire right, title and interest in and to the invention and in and to any letters patent that may be granted in the United States and in any and all foreign countries;

NOW, THEREFORE, in exchange for good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNOR(S) hereby sell, assign and transfer unto ASSIGNEE, the entire right, title and interest in and to said application and any and all letters patent which may be granted for said invention in the United States of America and its territorial possessions and in any and all foreign countries, and in any and all divisions, reissues and continuations thereof, including the right to file foreign applications directly in the name of ASSIGNEE and to claim priority rights deriving from said United States application to which said foreign applications are entitled by virtue of international convention, treaty or otherwise, said invention, application and all letters patent on said invention to be held and enjoyed by ASSIGNEE and its successors and assigns for their use and benefit and of their successors and assigns as fully and entirely as the same would have been held and enjoyed by ASSIGNOR(S) had this assignment, transfer and sale not been made. ASSIGNOR(S) hereby authorize and request the Commissioner of Patents and Trademarks to issue all letters patent on said invention to ASSIGNEE. ASSIGNOR(S) agree to execute all instruments and documents required for the making and prosecution of applications for United States and foreign letters patent on said invention, for litigation regarding said letters patent, or for the purpose of protecting title to said invention or letters patent.

2/16/2016
Date

Steven W. Ellison
Steven W. Ellison

2/16/2016
Date

David Knaggs
David Knaggs